

Title (en)

Substrate of improved melt sprayed surface morphology

Title (de)

Substrat mit verbesserter Oberflächemorphologie mittels schmelzflüssigen Spritzens

Title (fr)

Substrat présentant une morphologie de surface améliorée par projection à l'état fondu

Publication

EP 0493326 B1 19970625 (EN)

Application

EP 91810992 A 19911220

Priority

US 63391490 A 19901226

Abstract (en)

[origin: EP0493326A2] A metal surface is now described having enhanced adhesion of subsequently applied coatings. The substrate metal of the article, such as a valve metal as represented by titanium, is provided with a highly desirable surface characteristic for subsequent coating application. This can be achieved by a plasma sprayed coating of well defined surface morphology, the plasma spraying being with one or more metals usually valve metals. The metal of the coating may be the same or different from the metal of the substrate. Subsequently applied coatings, by penetrating into the coating of well defined surface morphology, and desirably locked onto the resulting metal article an provide enhanced lifetime even in rugged commercial environments.

IPC 1-7

C25B 11/00; **C25C 7/02**; **C23C 4/02**; **C25D 17/10**; **C23C 28/00**

IPC 8 full level

C23C 4/02 (2016.01); **C23C 4/02** (2006.01); **C23C 8/02** (2006.01); **C23C 26/00** (2006.01); **C23C 28/00** (2006.01); **C23F 1/00** (2006.01); **C25B 11/00** (2006.01); **C25B 11/10** (2006.01); **C25C 7/02** (2006.01); **C25D 1/04** (2006.01); **C25D 17/10** (2006.01); **C25D 17/12** (2006.01)

CPC (source: EP)

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Citation (examination)

CHEMICAL ABSTRACTS, vol. 1111, no. 24, 11 December 1989, Columbus, Ohio, US; abstract no. 221016x, KATSURADA 'nonconsumable anode for electroplating' page 447 ;column 111 ; & JP-A-01150000

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